## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: J.-S. Mok et al. Attorney Docket No.: LEPA121687

Application No.: 10/677,182

Art Unit: 1765 / Confirmation No: 8329

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Examiner: S. Ahmed

Title:

METHOD OF FORMING SOLDER RESIST PATTERN

## AMENDMENT

Seattle, Washington 98101

June 28, 2007

## TO THE COMMISSIONER FOR PATENTS:

## INTRODUCTORY COMMENTS

Please amend the above-identified application as follows.